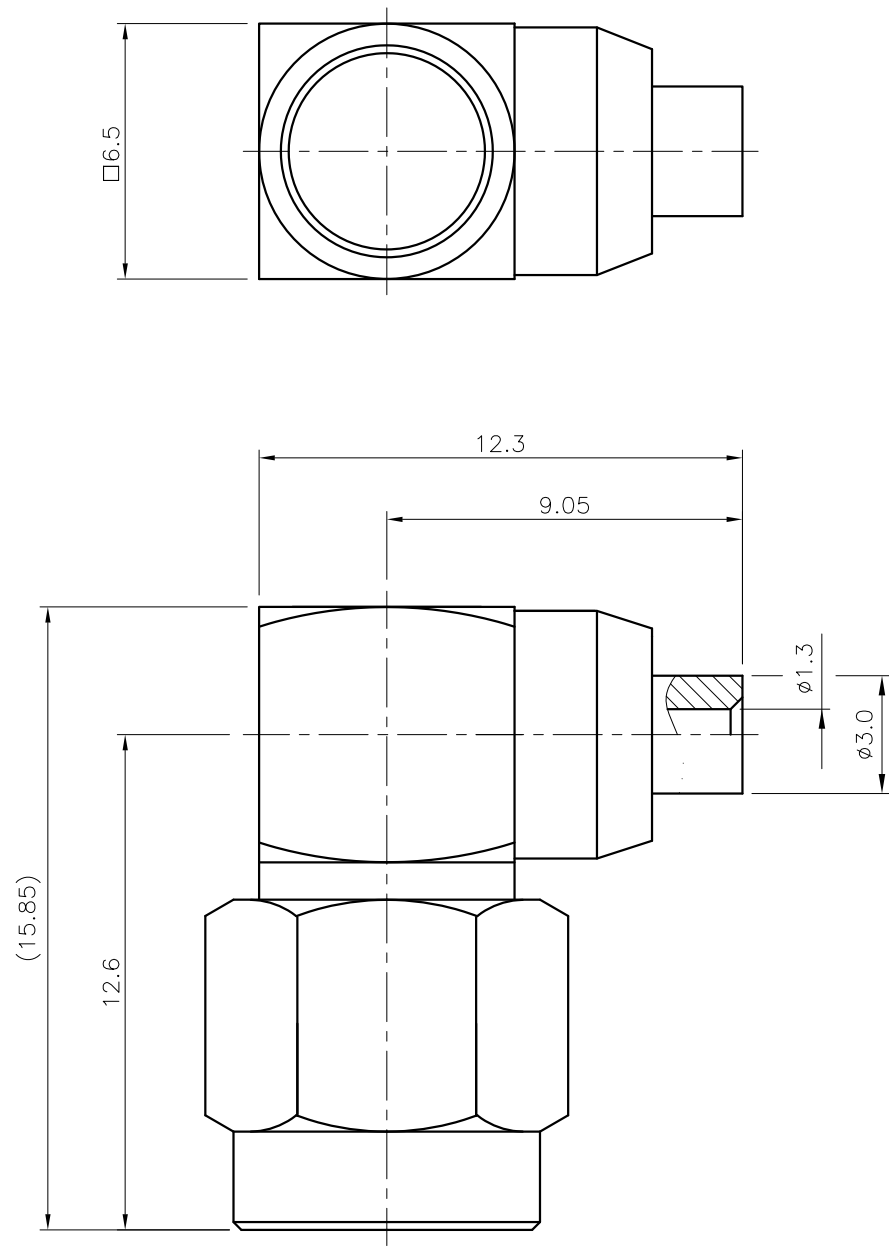
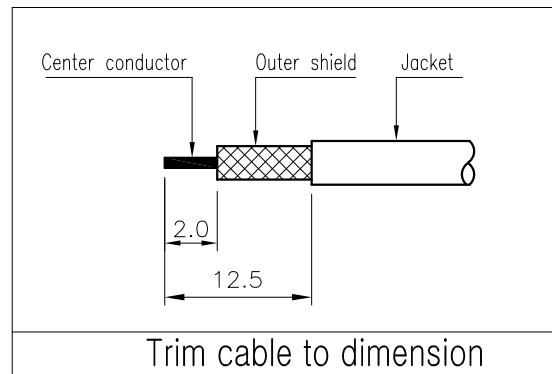




REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	S.Y.EUN	I.C.KIM	2020.11.09.
i	CN02748-7/5 ↔ CN02748-7/6 BOM 크로스 전환	S.Y.EUN	I.C.KIM	2020.11.10.



9	RING	1	SUS	부동태 처리	DSR00002-5/1
8	COVER	1	MBsBD C3604BD-F	Nickel Plate	DCO00114-5/1
7	CAP	1	MBsBD C3604BD-F	Nickel Plate	DCU00005-5/2
6	INSULATOR	1	TEFLON		DIN00921-N/1
5	INSULATOR	1	TEFLON		DIN02129-N/1
4	GASKET	1	SILICONE RUB		DGK00004-N/1
3	CONTACT	1	MBsBD C3604BD-F	Gold Plate	DCT00300-5/6
2	BODY (B)	1	MBsBD C3604BD-F	Gold Plate	DBD03252-5/5
1	BODY (A)	1	ZnDC	Nickel Plate (3~4μm)	DBD02994-5/3
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal ±0.2	DATE 2020. 11. 10.			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017 KJ COMTECH CO.,LTD.		
	Angle ±1°	APPROVED BY	I.C.KIM				
MATERIAL		CHECKED BY			TITLE SMA50 CABLE PL 47TP		
		DRAWN BY S.Y.EUN					
FINISH		SCALE 5/1	UNIT mm		A4	DWG NO. CN02748-7/5	
						REVISION 1	SHEET 1 of 1